

L Number	Hits	Search Text	DB	Time stamp
1	1	5204574.pn.	USPAT; US-PPGPUB	2002/06/10 15:04
2	1	6369484.pn.	USPAT; US-PPGPUB	2002/06/10 15:05
-	413	commutator and molding and (projec\$5 or hooks)	USPAT; US-PPGPUB	2002/06/10 15:04
-	1	310/233.cccls. and ( mold\$3 near (projec\$5 or hooks))	USPAT; EPO; JPO; DERWENT; IBM TDB	2002/06/07 11:38
-	691	310/233.cccls.	USPAT; EPO; JPO; DERWENT; IBM TDB	2002/06/07 13:36
-	250	310/234.cccls.	USPAT; EPO; JPO; DERWENT; IBM TDB	2002/06/07 13:37
-	0	310/42 and 233.cccls. and commutat\$3 same (bar near conductor) and (mold\$3 adj resin) near (cylinder adj shape)	USPAT	2002/06/10 14:17
-	0	310/42 and 233.cccls. and commutat\$3 same (mold\$3 adj resin) near (cylinder adj shape)	USPAT	2002/06/10 14:55
-	0	310/42 and 233.cccls. and commutat\$3 near (mold\$3 adj resin) near (cylinder adj shape)	USPAT	2002/06/10 14:19
-	0	310/42 and 233.cccls. and commutator	USPAT	2002/06/10 14:18
-	0	310/42.cccls. and commutat\$3 near (mold\$3 adj resin) near (cylinder adj shape)	USPAT	2002/06/10 14:20
-	0	310/42.cccls. and commutat\$3 and (mold\$3 adj resin) and (cylinder adj shape)	USPAT	2002/06/10 14:20
-	8	310/42.cccls. and commutat\$3 and (mold\$3 adj resin)	USPAT	2002/06/10 14:23
-	0	310/42 and 233.cccls. and commutat\$3 and (mold\$3 adj resin)	USPAT	2002/06/10 14:38
-	0	310/136.cccls. and commutat\$3 and (mold\$3 adj resin)	USPAT	2002/06/10 14:23
-	8	310/42.cccls. and commutat\$3 and (mold\$3 adj resin)	USPAT; US-PPGPUB; EPO; JPO; DERWENT; IBM TDB	2002/06/10 14:23
-	19	310/42,233.cccls. and commutat\$3 and (mold\$3 adj resin)	USPAT	2002/06/10 14:28
-	0	310/136.cccls. and commutat\$3 and (mold\$3 adj resin)	USPAT	2002/06/10 14:28
-	27	310/42,233.cccls. and commutat\$3 and (mold\$3 adj resin)	USPAT; US-PPGPUB; EPO; JPO; DERWENT; IBM TDB	2002/06/10 14:29
-	1	6369484.pn.	USPAT	2002/06/10 14:39
-	1	5204574.pn.	USPAT	2002/06/10 14:40
-	0	310/235.cccls. and commutat\$3 same (mold\$3 adj resin) near (cylinder adj shape)	USPAT	2002/06/10 14:56
-	14	310/235.cccls. and commutat\$3 same (mold\$3 adj resin)	USPAT; US-PPGPUB; EPO; JPO; DERWENT; IBM TDB	2002/06/10 14:58

-	6	310/236.cccls. and commutat\$3 same (mold\$3 adj resin)	USPAT; US-PPGPUB; EPO; JPO; DERWENT; IBM TDB	2002/06/10 14:58
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